

# **BGY67A**

# 200 MHz, 24 dB gain reverse amplifier Rev. 5 — 19 September 2011

Product data sheet

#### 1. **Product profile**

### 1.1 General description

Hybrid high dynamic range amplifier module in a SOT115J package operating at a voltage supply of 24 V (DC).

### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

### 1.2 Features and benefits

- Excellent linearity
- Extremely low noise
- Silicon nitride passivation
- Rugged construction
- TiPtAu metallized crystals ensure optimal reliability

### 1.3 Applications

Reverse amplifier in two-way CATV systems in the 5 MHz to 200 MHz frequency

### 1.4 Quick reference data

Table 1. Quick reference data

| Symbol           | Parameter                      | Conditions | Min          | Тур | Max  | Unit |
|------------------|--------------------------------|------------|--------------|-----|------|------|
| $G_p$            | power gain                     | f = 10 MHz | 23.5         | -   | 24.5 | dB   |
| I <sub>tot</sub> | total current consumption (DC) |            | <u>[1]</u> _ | 215 | 230  | mA   |

<sup>[1]</sup> The module normally operates at  $V_B = 24 \text{ V}$ , but is able to withstand supply transients up to 30 V.



# 2. Pinning information

Table 2. Pinning

| Pin | Description     | Simplified outline | Symbol        |  |
|-----|-----------------|--------------------|---------------|--|
| 1   | input           |                    |               |  |
| 2   | common          | 1 3 5 7 9          | 5             |  |
| 3   | common          |                    | $\frac{1}{2}$ |  |
| 5   | +V <sub>B</sub> |                    | 2 3 7 8       |  |
| 7   | common          |                    | sym095        |  |
| 8   | common          |                    | ,             |  |
| 9   | output          |                    |               |  |

# 3. Ordering information

Table 3. Ordering information

| Туре   | Package |  |         |  |  |  |
|--------|---------|--|---------|--|--|--|
| number | Name    | Description  | Version |  |  |  |
| BGY67A | -       | rectangular single-ended package; aluminium flange; 2 vertical mounting holes; $2 \times 6$ -32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads | SOT115J |  |  |  |

### 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol           | Parameter                 | Conditions | Min | Max  | Unit |
|------------------|---------------------------|------------|-----|------|------|
| $V_i$            | RF input voltage          |            | -   | 65   | dBmV |
| T <sub>stg</sub> | storage temperature       |            | -40 | +100 | °C   |
| $T_{mb}$         | mounting base temperature |            | -20 | +90  | °C   |

### 5. Characteristics

Table 5. Characteristics

Bandwidth 5 MHz to 200 MHz;  $V_B = 24 \text{ V}$ ;  $T_{mb} = 30 \text{ °C}$ ;  $Z_S = Z_L = 75 \Omega$ ; unless otherwise specified.

| Symbol           | Parameter                      | Conditions  | Min               | Тур | Max  | Unit |
|------------------|--------------------------------|---|-------------------|-----|------|------|
| $G_p$            | power gain                     | f = 10 MHz  | 23.5              | -   | 24.5 | dB   |
| SL               | slope cable equivalent         | f = 5 MHz to 200 MHz  | -0.2              | -   | +0.5 | dB   |
| FL               | flatness of frequency response | f = 5 MHz to 200 MHz  | -                 | -   | ±0.2 | dB   |
| S <sub>11</sub>  | input return losses            | f = 5 MHz to 200 MHz  | 20                | -   | -    | dB   |
| S <sub>22</sub>  | output return losses           | f = 5 MHz to 200 MHz  | 20                | -   | -    | dB   |
| СТВ              | composite triple beat          | 22 channels flat; V <sub>o</sub> = 50 dBmV;<br>measured at 175.25 MHz | -                 | -   | -67  | dB   |
| $X_{mod}$        | cross modulation               | 22 channels flat; $V_o = 50 \text{ dBmV}$ ; measured at 55.25 MHz     | -                 | -   | -59  | dB   |
| $d_2$            | second order distortion        | $V_0 = 50 \text{ dBmV}$   | <u>[1]</u> _      | -   | -67  | dB   |
| Vo               | output voltage                 | $d_{im} = -60 \text{ dB}$   | <sup>[2]</sup> 67 | -   | -    | dBmV |
|                  |                                |   | [ <u>3]</u> 64    | -   | -    | dBmV |
| F                | noise figure                   | f = 200 MHz   | -                 | -   | 5.5  | dB   |
| I <sub>tot</sub> | total current consumption (DC) |   | [4] _             | 215 | 230  | mA   |

<sup>[1]</sup>  $f_p = 83.25$  MHz;  $V_p = 50$  dBmV;  $f_q = 109.25$  MHz;  $V_q = 50$  dBmV; measured at  $f_p + f_q = 192.5$  MHz.

<sup>[2]</sup> Measured according to DIN45004B;  $f_p = 35.25 \text{ MHz}; \ V_o = V_p; \ f_q = 42.25 \text{ MHz}; \ V_q = V_o - 6 \text{ dB}; \ f_r = 44.25 \text{ MHz}; \ V_r = V_o - 6 \text{ dB}; \ measured at \ f_p + f_q - f_r = 33.25 \text{ MHz}.$ 

<sup>[3]</sup> Measured according to DIN45004B;  $f_p = 187.25 \text{ MHz}$ ;  $V_o = V_p$ ;  $f_q = 194.25 \text{ MHz}$ ;  $V_q = V_o - 6 \text{ dB}$ ;  $f_r = 196.25 \text{ MHz}$ ;  $V_r = V_o - 6 \text{ dB}$ ; measured at  $f_p + f_q - f_r = 185.25 \text{ MHz}$ .

<sup>[4]</sup> The module normally operates at  $V_B = 24 \text{ V}$ , but is able to withstand supply transients up to 30 V.

### 6. Package outline

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads

SOT115J

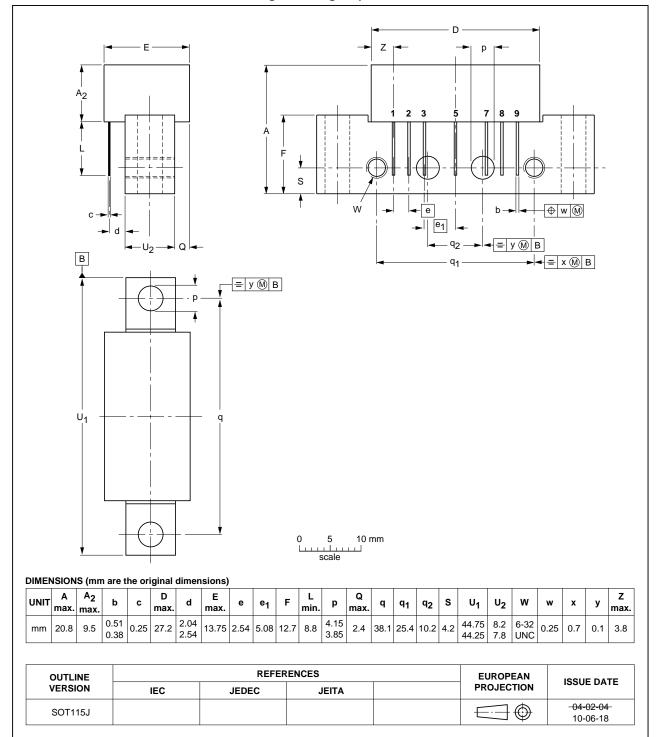


Fig 1. Package outline SOT115J

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# 200 MHz, 24 dB gain reverse amplifier

# 7. Revision history

### Table 6. Revision history

| Release date  | Data sheet status   | Change notice   | Supersedes  |
|---------------|---|---|---|
| 20110919      | Product data sheet  | -   | BGY67A v.4  |
| guidelines of | NXP Semiconductors.   |   | •   |
| •             | •   | • •   | • • •   |
| 20050314      | Product data sheet  | -   | BGY67A v.3  |
| 20011018      | Product specification   | -   | BGY67A v.2  |
| 19970409      | Product specification   | -   | BGY67A v.1  |
|               | 20110919  The format of guidelines of Legal texts hear Package out 20050314  20011018 | <ul> <li>20110919 Product data sheet</li> <li>The format of this data sheet has been redeguidelines of NXP Semiconductors.</li> <li>Legal texts have been adapted to the new of Package outline drawings have been updated 20050314 Product data sheet</li> <li>20011018 Product specification</li> </ul> | <ul> <li>Product data sheet -</li> <li>The format of this data sheet has been redesigned to comply w guidelines of NXP Semiconductors.</li> <li>Legal texts have been adapted to the new company name where Package outline drawings have been updated to the latest version 20050314</li> <li>Product data sheet -</li> <li>Product specification -</li> </ul> |

### 8. Legal information

#### 8.1 Data sheet status

| Document status[1][2]          | Product status[3] | Definition  |
|--------------------------------|-------------------|---|
| Objective [short] data sheet   | Development       | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification     | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production        | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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### 200 MHz, 24 dB gain reverse amplifier

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